

DB2J40600L

Schottky Barrier Diode DB2J40600L

Silicon epitaxial planar type

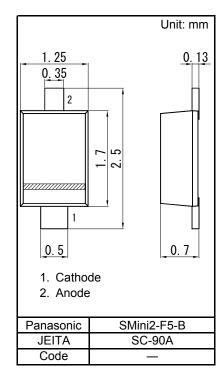
For high speed switching circuits

- Features
- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

Marking Symbol:4Q

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit			
Reverse voltage	VR	40	V			
Repetitive peak reverse voltage	VRRM	40	V			
Average forward current	IF (AV)	100	mA			
Peak forward current	IFM	300	mA			
Non-repetitive peak forward surge current *1	IFSM	1	А			
Junction temperature	Tj	125	°C			
Operating ambient temperature	Topr	-40 to +85	°C			
Storage temperature	Tstg	-55 to +125	°C			

Internal Connection

Note: *1 50Hz sine wave 1 cycle (Non-repetitive peak current)

Doc No. TT4-EA-13098 Revision. 2

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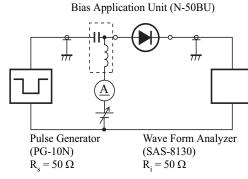
■ Electrical Characteristics Ta = 25 °C ± 3 °C

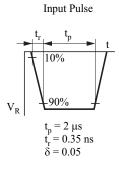
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA			0.6	V
Reverse current	IR	VR = 40 V			5	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		2.2		pF
Reverse recovery time *1	trr	IF = IR = 100 mA, Irr = 10 mA		0.9		ns

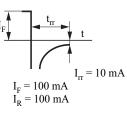
Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of Input and output is 250 MHz
- 4. *1 : trr measurement circuit

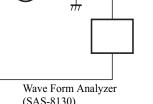






Output Pulse

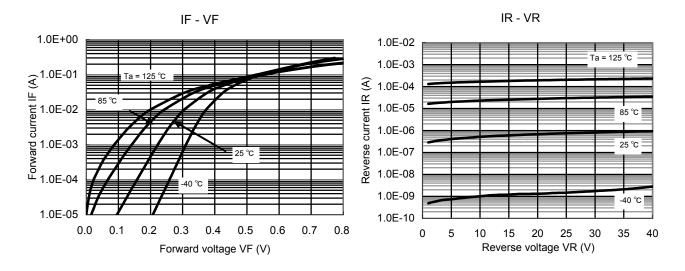
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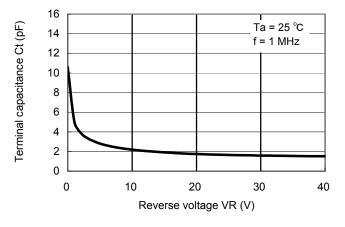
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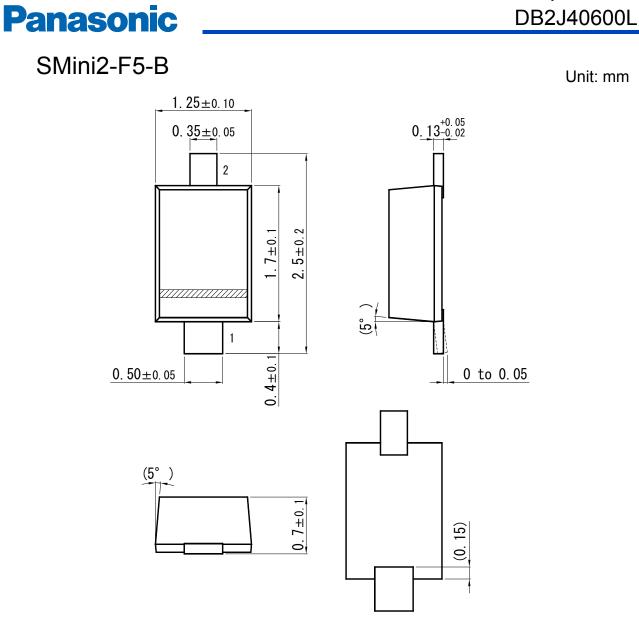
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Technical Data (reference)

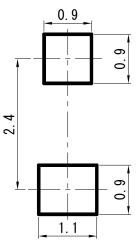








■ Land Pattern (Reference) (Unit: mm)



Schottky Barrier Diode

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